## AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application: LISTING OF CLAIMS:

1. (currently amended): A cover sheet package, comprising:

a thin film cover sheet including a resin film and, the thin film cover sheet having an adhesive film formed on one side surface of the resin film, wherein the cover sheet is configured to be and which is adhered via the adhesive film to a recording surface of a disk substrate of an ontical disk:

a peeling sheet which is peelably adhered on a surface of the adhesive film of the cover sheet and which is peeled before the cover sheet is adhered to the recording surface of the disk substrate; and

a protective sheet which is peelably adhered on a surface of the resin film of the cover sheet.

wherein, when an adhesive force for adhering the peeling sheet to the adhesive film of the cover sheet is indicated by  $AP_1$  and an adhesive force for adhering the protective sheet to the resin film of the cover sheet is indicated by  $AP_2$ , the peeling sheet is adhered to the adhesive film of the cover sheet and the protective sheet is adhered to the resin film of the cover sheet so that the relationship  $AP_1 \le AP_2$  is satisfied.

wherein the adhesive force  $AP_1$  is set to be a value selected from a range of 5 to 50 (gf/cm), and the adhesive force  $AP_2$  is set to be a value selected from a range of  $(AP_1 \times 1.0)$  to  $(AP_1 \times 3.0)$ , and

wherein a total thickness of the cover sheet, the resin film and the adhesive film is a value in a range from 80 um to 110 um.

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2. - 9. (canceled).

 (previously presented): The cover sheet package of claim 1, wherein peeling material including silicone is coated on a surface of the peeling sheet which adheres to the

adhesive film.

11. (previously presented): The cover sheet package of claim 10, wherein adhesive

material including vinyl acetate is coated on a surface of the protective sheet which adheres to

the resin film.

12. (canceled).

13. (new): A cover sheet package and an optical disk, comprising:

the optical disk; and

the cover sheet package, comprising

a thin film cover sheet including a resin film and an adhesive film formed on one side

surface of the resin film, wherein the cover sheet is configured to be adhered via the adhesive

film to a recording surface of a disk substrate of the optical disk in a manner such that

information recorded on the optical disk can be read;

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a peeling sheet which is peelably adhered on a surface of the adhesive film of the cover sheet and which is peeled before the cover sheet is adhered to the recording surface of the disk substrate; and

a protective sheet which is peelably adhered on a surface of the resin film of the cover sheet.

wherein, when an adhesive force for adhering the peeling sheet to the adhesive film of the cover sheet is indicated by  $AP_1$  and an adhesive force for adhering the protective sheet to the resin film of the cover sheet is indicated by  $AP_2$ , the peeling sheet is adhered to the adhesive film of the cover sheet and the protective sheet is adhered to the resin film of the cover sheet so that the relationship  $AP_1 \le AP_2$  is satisfied,

wherein the adhesive force AP<sub>1</sub> is set to be a value selected from a range of 5 to 50 (gf/cm), and the adhesive force AP<sub>2</sub> is set to be a value selected from a range of (AP<sub>1</sub> × 1.0) to (AP<sub>1</sub> × 3.0), and

wherein a total thickness of the cover sheet, the resin film and the adhesive film is a value in a range from 80 um to 110 um.

14. (new): The cover sheet package and the optical disk of claim 13, wherein peeling material including silicone is coated on a surface of the peeling sheet which adheres to the adhesive film.

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15. (new): The cover sheet package and the optical disk of claim 14, wherein adhesive material including vinyl acetate is coated on a surface of the protective sheet which adheres to the resin film.